



NEW TECHNOLOGY OVERMAN

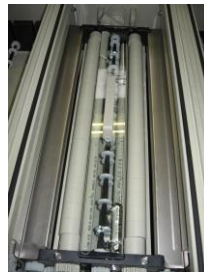


HOT AIR SOLDER LEVELER

Available types : 18"x18" up to 30"x30"
PLC controlled or electrical controlled version
Lead Tin, Lead Free application.

HCL LINES / SPECIAL PRODUCTS

Polypropylene lines or applications :
Rinse/dryer, pre- and postcleaning, fluxers, dosing
units, mix and buffer tanks, Customized, Prototype
and specials.



VERTICAL PLATING LINES (VPL)

Automatic plating lines for
plating through hole-copper
plating and pattern plating,
ENIG, ENIPIG lines etc.
Plating lines for research,
development and manual
manufacturing.

New Technology Overman specialises in designing, developing, Manufacturing and supply complete Hot Air Solder Levellers, HASL Process lines, Vertical Plating lines and equipment for surface treatment processes in the Printed Circuit Board industry.